

MOS FIELD EFFECT TRANSISTOR 2SK2409

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2409 is N-Channel MOS Field Effect Transistor designed for solenoid, motor, and lamp driver.

FEATURES

- Low On-Resistance
 - $R_{DS(on)} \le 27 \ m\Omega \ (V_{GS} = 10 \ V, \ I_{D} = 20 \ A)$
 - $R_{DS(on)} \le 40 \ m\Omega \ (V_{GS} = 4 \ V, \ I_{D} = 20 \ A)$
- Low Ciss Ciss = 2040 pF TYP.
- · Built-in Gate Protection Diode

QUALITY GRADE

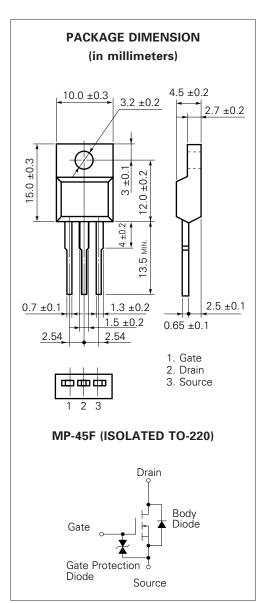
Standard

Please refer to "Quality grade on NEC Semiconductor Device" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±40	Α
Drain Current (pulse)	ID(pulse)*	±160	Α
Total Power Dissipation (Ta = 25 °C)	P _{T1}	2.0	W
Total Power Dissipation (Tc = 25 °C)	P _{T2}	35	W
Channel Temperature	Tch	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C
Single Avalanche Current	As**	40	Α
Single Avalanche Energy	Eas**	160	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



The information in this document is subject to change without notice.

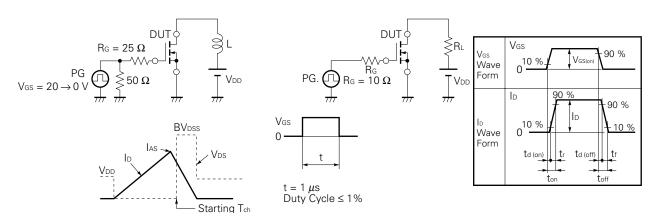


ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

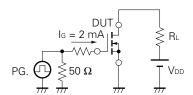
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	RDS(on)1		22	27	mΩ	Vgs = 10 V, ID = 20 A
Drain to Source On-State Resistance	R _{DS(on)2}		30	40	mΩ	VGS = 4 V, ID = 20 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0	1.5	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l y _{fs} l	20	35		S	V _{DS} = 10 V, I _D = 20 A
Drain Cutoff Current	IDSS			10	μΑ	V _{DS} = 60 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		2040		pF	V _{DS} = 10 V
Output Capacitance	Coss		1080		pF	V _G S = 0
Reverse Transfer Capacitance	Crss		300		pF	f = 1 MHz
Turn-On Delay Time	td(on)		30		ns	ID = 20 A
Rise Time	tr		350		ns	VGS(on) = 10 V
Turn-Off Delay Time	td(off)		210		ns	V _{DD} = 30 V
Fall Time	tf		260		ns	$R_G = 10 \Omega$
Total Gate Charge	QG		72		nC	ID = 40 A
Gate to Source Charge	Qgs		6.0		nC	V _{DD} = 48 V
Gate to Drain Charge	Q _{GD}		24		nC	V _{GS} = 10 V
Body Diode Forward Voltage	V _{F(S-D)}		1.1		V	IF = 40 A, VGS = 0
Reverse Recovery Time	trr		110		ns	IF = 40 A, VGS = 0
Reverse Recovery Charge	Qrr		360		nC	di/dt = 100 A/μs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

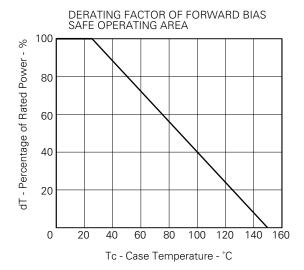


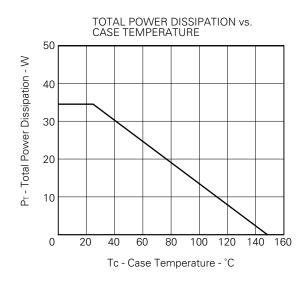
Test Circuit 3 Gate Charge

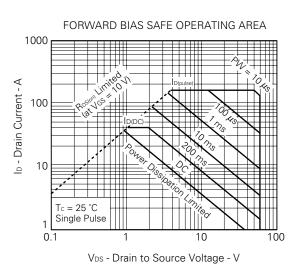


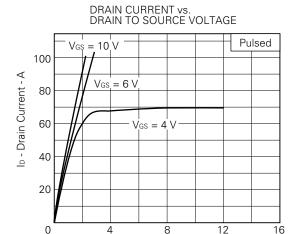


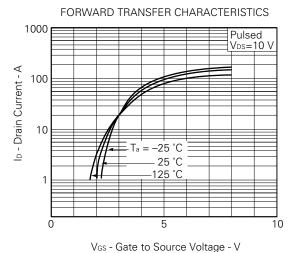
TYPICAL CHARACTERISTICS (Ta = 25 °C)





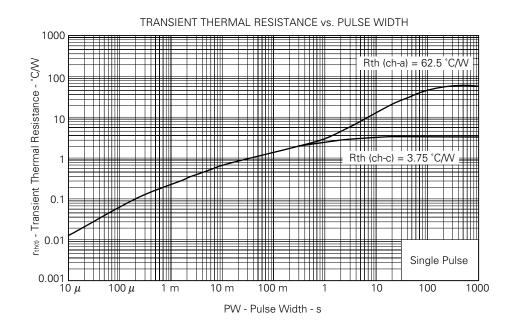


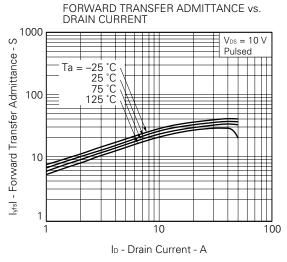


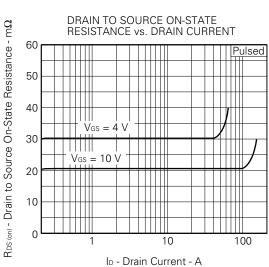


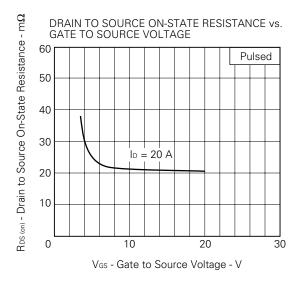
V_{DS} - Drain to Source Voltage - V

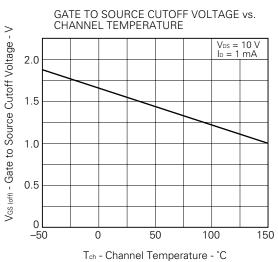




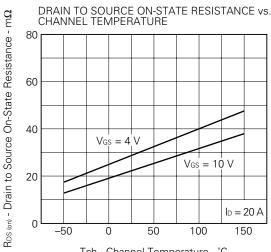


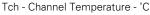


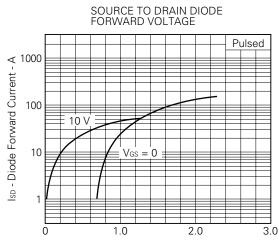




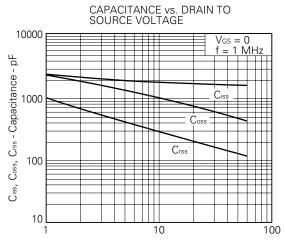




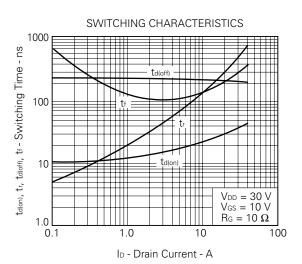




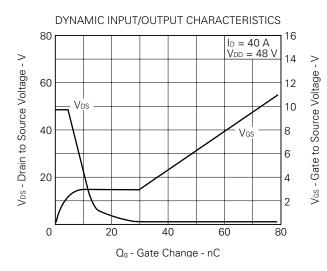
VsD - Source to Drain Voltage - V



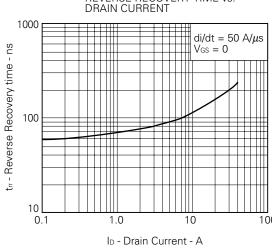
V_{DS} - Drain to Source Voltage - V



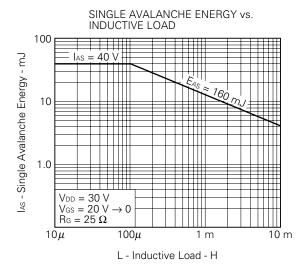


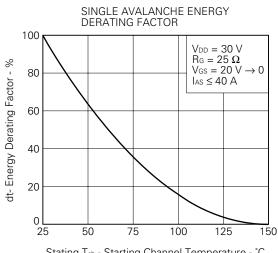


REVERSE RECOVERY TIME vs. DRAIN CURRENT









Stating Tch - Starting Channel Temperature - °C



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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